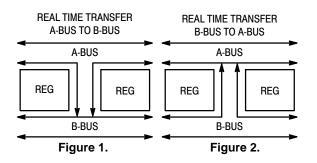
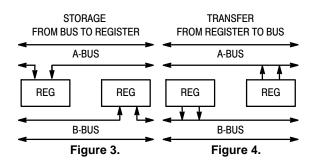
Octal Transceiver/Register with 3-State Outputs (Non-inverting)

The MC74AC646/74ACT646 consist of registered bus transceiver circuits, with outputs, D-type flip-flops and control circuitry providing multiplexed transmission of data directly from the input bus or from the internal storage registers. Data on the A or B bus will be loaded into the respective registers on the LOW-to-HIGH transition of the appropriate clock pin (CAB or CBA). The four fundamental data handling functions available are illustrated Figures 1 to 4.

Features

- Independent Registers for A and B Buses
- Multiplexed Real-Time and Stored Data Transfers
- Choice of True and Inverting Data Paths
- 3-State Outputs
- 300 mil Slim Dual In-Line Package
- Outputs Source/Sink 24 mA
- 'ACT646 Has TTL Compatible Inputs
- These are Pb–Free Devices

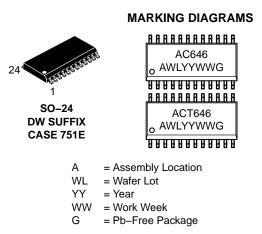






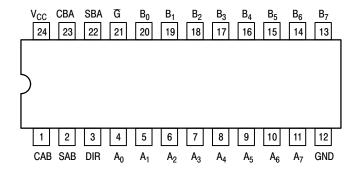
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ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.



PIN ASSIGNMENT

PIN	FUNCTION
A ₀ -A ₇	Data Register Inputs Data Register A Outputs
B ₀ –B ₇	Data Register B Inputs Data Register B Outputs
CAB, CBA	Clock Pulse Inputs
SAB, SBA	Transmit/Receive Inputs
DIR, G	Output Enable Inputs

Figure 5. Pinout: 24–Lead Packages Conductors

(Top View)

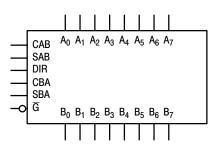
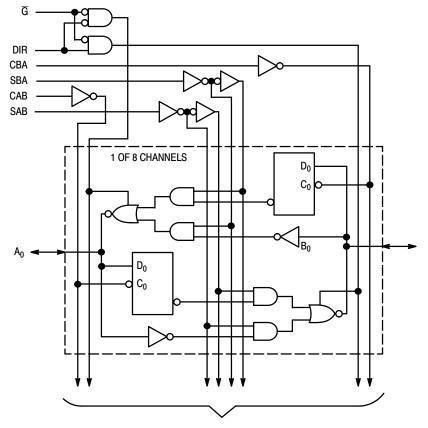


Figure 6. Logic Symbol



TO 7 OTHER CHANNELS

NOTE: This diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 7. Logic Diagram

FUNCTION TABLE

Inputs						Data	I/O*	Operation or Function			
G	DIR	CAB	CBA	SAB	SBA	A ₀ -A ₇	B ₀ -B ₇	Operation of Function			
H H	X X	H or L	H or L	X X	X X	Input	Input	Isolation Store A and B Data			
L	L L	X X	X X	X X	L H	Output	Input	Real Time B Data to A Bus Stored B Data to A Bus			
L	H H	X H or L	X X	L H	X X	Input	Output	Real Time A Data to B Bus Stored A Data to B Bus			

*The data output functions may be enabled or disabled by various signals at the \overline{G} and DIR inputs. Data input functions are always enabled; i.e., data at the bus pins will be stored on every LOW-to-HIGH transition of the appropriate clock inputs.

NOTE: H = HIGH Voltage Level; L = LOW Voltage Level; X = Immaterial; J = LOW-to-HIGH Transition

MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)		-0.5 to +7.0	V
V _{IN}	DC Input Voltage (Referenced to GND)		–0.5 to V _{CC} +0.5	V
V _{OUT}	DC Output Voltage (Referenced to GND) (Note 1)	–0.5 to V _{CC} +0.5	V	
Ι _{ΙΚ}	DC Input Diode Current	±20	mA	
I _{OK}	DC Output Diode Current	±50	mA	
I _{OUT}	DC Output Sink/Source Current	±50	mA	
I _{CC}	DC Supply Current, per Output Pin	±50	mA	
I _{GND}	DC Ground Current, per Output Pin	±100	mA	
T _{STG}	Storage Temperature Range	-65 to +150	°C	
ΤL	Lead temperature, 1 mm from Case for 10 Seconds		260	°C
Τ _J	Junction Temperature Under Bias		140	°C
θ_{JA}	Thermal Resistance (Note 2)		59.8	°C/W
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating Oxygen Ir	ndex: 30% – 35%	UL 94 V–0 @ 0.125 in	
V _{ESD}	Machin	ly Model (Note 3) e Model (Note 4) e Model (Note 5)	> 2000 > 200 > 1000	V
I _{Latchup}	Latchup Performance Above V _{CC} and Below GND	at 85°C (Note 6)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I_{OUT} absolute maximum rating must be observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

3. Tested to EIA/JESD22-A114-A.

4. Tested to EIA/JESD22-A115-A.

5. Tested to JESD22-C101-A.

6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Тур	Max	Unit	
		′AC	2.0	5.0	6.0	N	
V _{CC}	V _{CC} Supply Voltage	'ACT	4.5	5.0	5.5	V	
V _{in} , V _{out}	DC Input Voltage, Output Voltage (Ref. to GND)	•	0	_	V _{CC}	V	
			_	150	-		
t _r , t _f	, t _f Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	V _{CC} @ 4.5 V	_	40	-	ns/V	
		V _{CC} @ 5.5 V	_	25	-		
	Input Rise and Fall Time (Note 2)	V _{CC} @ 4.5 V	_	10	-	τ ο Δ (
t _r , t _f	'ACT Devices except Schmitt Inputs	V _{CC} @ 5.5 V	_	8.0	-	ns/V	
T _A	Operating Ambient Temperature Range	-40	25	85	°C		
I _{OH}	Output Current – High		-	-	-24	mA	
I _{OL}	Output Current – Low		-	-	24	mA	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 1. V_{in} from 30% to 70% V_{CC} ; see individual Data Sheets for devices that differ from the typical input rise and fall times. 2. V_{in} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

DC CHARACTERISTICS

			74	AC	74AC		
Symbol	Parameter	V _{CC} (V)	T _A = -	+25°C	T _A = –40°C to +85°C	Unit	Conditions
			Тур	Guar	anteed Limits		
V _{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	V	I _{OUT} = -50 μA
		3.0 4.5 5.5	- - -	2.56 3.86 4.86	2.46 3.76 4.76	V	$\label{eq:VIN} \begin{array}{c} {}^{*}V_{IN} = V_{IL} \text{ or } V_{IH} \\ -12 \text{ mA} \\ I_{OH} -24 \text{ mA} \\ -24 \text{ mA} \end{array}$
V _{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	V	I _{OUT} = 50 μA
		3.0 4.5 5.5	- -	0.36 0.36 0.36	0.44 0.44 0.44	V	$\label{eq:VIN} \begin{array}{c} {}^{*}V_{IN} = V_{IL} \text{ or } V_{IH} \\ 12 \text{ mA} \\ I_{OL} \\ 24 \text{ mA} \\ 24 \text{ mA} \end{array}$
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μA	$V_{I} = V_{CC}, GND$
I _{OZT}	Maximum 3-State Current	5.5	_	±0.6	±6.0	μΑ	$V_{I} (OE) = V_{IL}, V_{IH}$ $V_{I} = V_{CC}, GND$ $V_{O} = V_{CC}, GND$
I _{OLD}	†Minimum Dynamic	5.5	-	-	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}	Output Current	5.5	-	-	-75	mA	V _{OHD} = 3.85 V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	_	8.0	80	μΑ	$V_{IN} = V_{CC}$ or GND

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

				74AC		74	AC		
Symbol	Parameter	V_{CC}^{*} $T_{A} = +25^{\circ}C$ (V) $C_{L} = 50 \text{ pF}$				Unit	Fig. No.		
			Min	Тур	Max	Min	Max		
t _{PLH}	Propagation Delay Clock to Bus	3.3 5.0	4.0 2.5	10.5 7.5	16.5 12	3.0 2.0	18.5 13	ns	3–6
t _{PHL}	Propagation Delay Clock to Bus	3.3 5.0	3.0 2.0	9.5 6.5	14.5 10.5	2.5 1.5	16 11.5	ns	3–6
t _{PLH}	Propagation Delay Bus to Bus	3.3 5.0	2.5 1.5	7.5 5.0	12 8.0	2.0 1.0	13.5 9.0	ns	3–5
t _{PHL}	Propagation Delay Bus to Bus	3.3 5.0	1.5 1.5	7.5 5.0	12.5 9.0	1.5 1.0	13.5 9.5	ns	3–5
t _{PLH}	Propagation Delay SBA or SAB to A_n or B_n (w/ A_n or B_n HIGH or LOW)	3.3 5.0	2.0 1.5	8.5 6.0	13.5 10	1.5 1.5	15.5 11	ns	3–6
t _{PHL}	Propagation Delay SBA or SAB to A_n or B_n (w/ A_n or B_n HIGH or LOW)	3.3 5.0	1.5 1.5	8.5 6.0	13.5 10	1.5 1.5	15 11	ns	3–6
t _{PZH}	Enable Time \overline{G} to A_n or B_n	3.3 5.0	2.5 1.5	7.0 5.0	11.5 8.5	2.0 1.5	12.5 9.0	ns	3–7
t _{PZL}	Enable Time \overline{G} to A_n or B_n	3.3 5.0	2.5 1.5	7.5 5.5	12.5 9.0	2.0 1.5	14 10	ns	3–8
t _{PHZ}	Disable Time \overline{G} to A_n or B_n	3.3 5.0	3.0 2.0	8.0 6.5	12.5 10	2.5 2.0	13.5 11	ns	3–7
t _{PLZ}	Disable Time \overline{G} to A_n or B_n	3.3 5.0	2.0 1.5	7.5 6.0	12 9.5	2.0 1.5	13.5 10.5	ns	3–8
t _{PZH}	Enable Time DIR to A _n or B _n	3.3 5.0	2.0 1.5	6.5 5.0	11 7.5	1.5 1.0	12 8.5	ns	3–7
t _{PZL}	Enable Time DIR to A _n or B _n	3.3 5.0	2.5 1.5	7.0 5.0	11.5 8.0	2.0 1.0	13 9.0	ns	3–8
t _{PHZ}	Disable Time DIR to A _n or B _n	3.3 5.0	2.5 1.5	7.5 5.5	11.5 9.5	1.5 1.5	12.5 10	ns	3–7
t _{PLZ}	Disable Time DIR to A _n or B _n	3.3 5.0	1.5 1.5	7.5 5.5	12 9.5	1.5 1.5	13.5 10.5	ns	3–8

AC CHARACTERISTICS (For Figures and Waveforms – See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

*Voltage Range 3.3 V is 3.3 V ± 0.3 V. Voltage Range 5.0 V is 5.0 V ± 0.5 V.

AC OPERATING REQUIREMENTS

			74AC		74AC							
Symbol	Parameter	V _{CC} * (V)	T _A = +25°C C _L = 50 pF		$T_A = +25 C$ C ₁ = 50 pE		T _A = +25°C C _L = 50 pF		$ \begin{array}{c} T_{A}=+25^{\circ}C \\ C_{L}=50 \ pF \end{array} \begin{array}{c} T_{A}=-40^{\circ}C \\ to \ +85^{\circ}C \\ C_{L}=50 \ pF \end{array} $		Unit	Fig. No.
			Typ Guaranteed		d Minimum							
t _s	Setup Time, HIGH or LOW Bus to Clock	3.3 5.0	2.0 1.5	5.0 4.0	5.5 4.5	ns	3–9					
t _h	Hold Time, HIGH or LOW Bus to Clock	3.3 5.0	-1.5 -0.5	0 0.5	0 1.0	ns	3–9					
t _w	Clock Pulse Width HIGH or LOW	3.3 5.0	2.0 2.0	3.5 3.5	4.5 3.5	ns	3–6					

*Voltage Range 3.3 V is 3.3 V ± 0.3 V. Voltage Range 5.0 V is 5.0 V ± 0.5 V.

DC CHARACTERISTICS

			744	СТ	74ACT				
Symbol	Parameter	V _{CC} (V)	T _A = -	+25°C	T _A = –40°C to +85°C	Unit	Conditions		
			Typ Guara		Typ Guara		anteed Limits		
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$		
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$		
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	V	I _{OUT} = -50 μA		
		4.5 5.5		3.86 4.86	3.76 4.76	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ -24 mA I_{OH} -24 mA		
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	V	I _{OUT} = 50 μA		
		4.5 5.5		0.36 0.36	0.44 0.44	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $V_{OL} = 24 \text{ mA}$ $V_{OL} = 24 \text{ mA}$		
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_{I} = V_{CC}, GND$		
ΔI_{CCT}	Additional Max. I _{CC} /Input	5.5	0.6	-	1.5	mA	$V_{I} = V_{CC} - 2.1 V$		
I _{OZT}	Maximum 3-State Current	5.5	_	±0.6	±6.0	μΑ			
I _{OLD}	†Minimum Dynamic	5.5	-	-	75	mA	V _{OLD} = 1.65 V Max		
I _{OHD}	Output Current	5.5	-	-	-75	mA	V _{OHD} = 3.85 V Min		
I _{CC}	Maximum Quiescent Supply Current	5.5	_	8.0	80	μΑ	$V_{IN} = V_{CC}$ or GND		

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

				74ACT		74A	СТ		
Symbol	Parameter	V _{CC} * (V)		_A = +25° S _L = 50 p		T _A = - to +8 C _L = 5	85°C	Unit	Fig. No.
			Min	Тур	Max	Min	Max		
t _{PLH}	Propagation Delay Clock to Bus	5.0	3.5	12.0	14.5	3.0	16.0	ns	3–6
t _{PHL}	Propagation Delay Clock to Bus	5.0	4.0	12.0	14.5	3.5	16.0	ns	3–6
t _{PLH}	Propagation Delay Bus to Bus	5.0	3.0	8.5	11.0	2.5	12.0	ns	3–5
t _{PHL}	Propagation Delay Bus to Bus	5.0	2.5	8.5	11.0	2.0	12.0	ns	3–5
t _{PLH}	Propagation Delay SBA or SAB to A_n or B_n (w/ A_n or B_n HIGH or LOW)	5.0	3.0	9.5	12.0	2.5	13.0	ns	3–6
t _{PHL}	Propagation Delay SBA or SAB to A_n or B_n (w/ A_n or B_n HIGH or LOW)	5.0	3.0	9.5	12.0	2.5	13.0	ns	3–6
t _{PZH}	Enable Time \overline{G} to A_n or B_n	5.0	2.0	9.0	11.0	1.5	12.0	ns	3–7
t _{PZL}	Enable Time \overline{G} to A_n or B_n	5.0	3.5	9.0	11.0	3.0	12.0	ns	3–8
t _{PHZ}	Disable Time \overline{G} to A_n or B_n	5.0	5.0	10.5	13.0	4.5	14.5	ns	3–7
t _{PLZ}	Disable Time \overline{G} to A_n or B_n	5.0	3.5	10.0	12.5	3.0	14.0	ns	3–8
t _{PZH}	Enable Time DIR to A _n or B _n	5.0	2.0	6.5	12.5	1.5	13.5	ns	3–7
t _{PZL}	Enable Time DIR to A _n or B _n	5.0	3.5	6.5	12.5	3.0	13.5	ns	3–8
t _{PHZ}	Disable Time DIR to A _n or B _n	5.0	5.0	8.5	12.5	4.5	13.5	ns	3–7
t _{PLZ}	Disable Time DIR to A _n or B _n	5.0	3.5	8.5	12.5	3.0	13.5	ns	3–8

AC CHARACTERISTICS (For Figures and Waveforms – See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

*Voltage Range 5.0 V is 5.0 V \pm 0.5 V.

AC OPERATING REQUIREMENTS

			74ACT $T_A = +25^{\circ}C$ $C_L = 50 \text{ pF}$ TypGuaranteed		74ACT		
Symbol	Parameter	V _{CC} * (V)					Fig. No.
					d Minimum		
ts	Setup Time, HIGH or LOW Bus to Clock	5.0	_	7.0	8.0	ns	3–9
t _h	Hold Time, HIGH or LOW Bus to Clock	5.0	_	2.5	2.5	ns	3–9
tw	Clock Pulse Width HIGH or LOW	5.0	_	7.0	8.0	ns	3–6

*Voltage Range 5.0 V is 5.0 V \pm 0.5 V.

CAPACITANCE

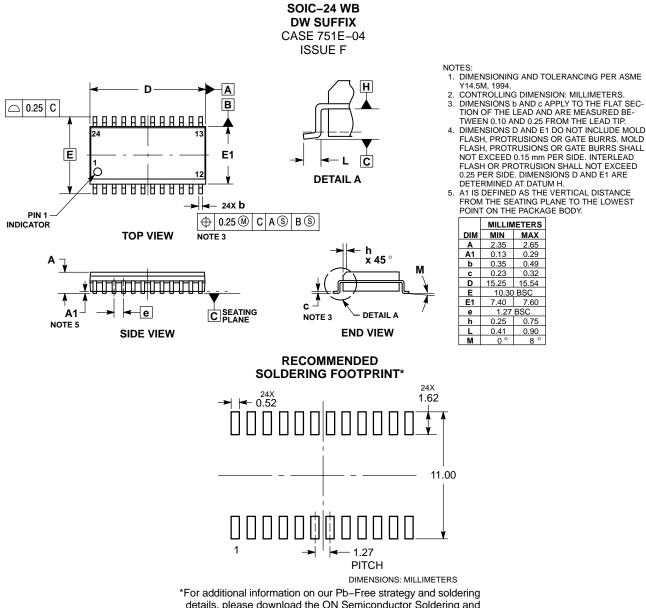
Symbol	Parameter	Value Typ	Unit	Test Conditions
C _{IN}	Input Capacitance	4.5	pF	$V_{CC} = 5.0 V$
C _{I/O}	Input/Output Capacitance	15	pF	$V_{CC} = 5.0 V$
C _{PD}	Power Dissipation Capacitance	60	pF	$V_{CC} = 5.0 V$

ORDERING INFORMATION

Device	Package	Shipping [†]
MC74AC646DWR2G		1000 / Tape & Reel
MC74ACT646DWG	SOIC-24 (Pb-Free)	30 Units / Rail
MC74ACT646DWR2G]	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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